

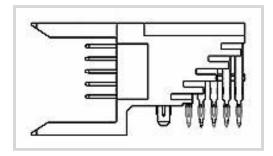
#### Z-PACK | Z-PACK Future Bus+

TE Internal #: 5223524-1 Backplane Connector Housings, Board-to-Board, 30 Position, 5 Row, 6 Column, Housing for Male Terminals, Sealable, Z-PACK Future Bus+

#### View on TE.com >



Connectors > PCB Connectors > Backplane Connectors > Backplane Connector Housings



#### Connector System: Board-to-Board

Number of Positions: **30** 

Centerline (Pitch): 2 mm

Row-to-Row Spacing: 2 mm

Number of Rows: 5

## Features

## Product Type Features

Connector SystemBoard-to-BoardConnector & Housing TypeHousing for Male TerminalsSealableYes

| Connector & Contact Terminates To | Printed Circuit Board |
|-----------------------------------|-----------------------|
| Configuration Features            |                       |
| Number of Positions               | 30                    |
| Number of Rows                    | 5                     |
| Number of Columns                 | 6                     |
| Contact Features                  |                       |
| Contact Current Rating (Max)      | 1 A                   |
| Mechanical Attachment             |                       |
| Connector Mounting Type           | Board Mount           |
| Housing Features                  |                       |
| Centerline (Pitch)                | 2 mm                  |
| Dimensions                        |                       |
| Row-to-Row Spacing                | 2 mm                  |
| Usage Conditions                  |                       |
|                                   |                       |

**C** For support call+1 800 522 6752

## 5223524-1

Backplane Connector Housings, Board-to-Board, 30 Position, 5 Row, 6 Column, Housing for Male Terminals, Sealable, Z-PACK Future Bus+



| Operating Temperature Range   | -55 – 125 °C  |  |  |  |
|---|---|--|--|--|
| Operation/Application   |   |  |  |  |
| Circuit Application   | Signal  |  |  |  |
| Product Compliance<br>For compliance documentation, visit the product page on TE.com> |   |  |  |  |
| EU RoHS Directive 2011/65/EU  | Compliant   |  |  |  |
| EU ELV Directive 2000/53/EC   | Compliant   |  |  |  |
| China RoHS 2 Directive MIIT Order No 32, 2016   | No Restricted Materials Above ThresholdCurrent ECHA Candidate List: JUNE 2023<br>(235)Candidate List Declared Against: JUNE<br>2023 (235)Does not contain REACH SVHCBFR/CFR/PVC Free, but Br/Cl >900 ppm in<br>other sources. |  |  |  |
| EU REACH Regulation (EC) No. 1907/2006  |   |  |  |  |
| Halogen Content   |   |  |  |  |
| Solder Process Capability   | Not applicable for solder process capability  |  |  |  |
| Product Compliance Disclaimer   |   |  |  |  |

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

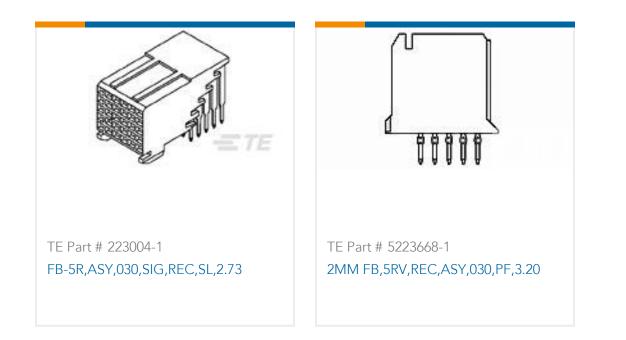
# **Compatible Parts**



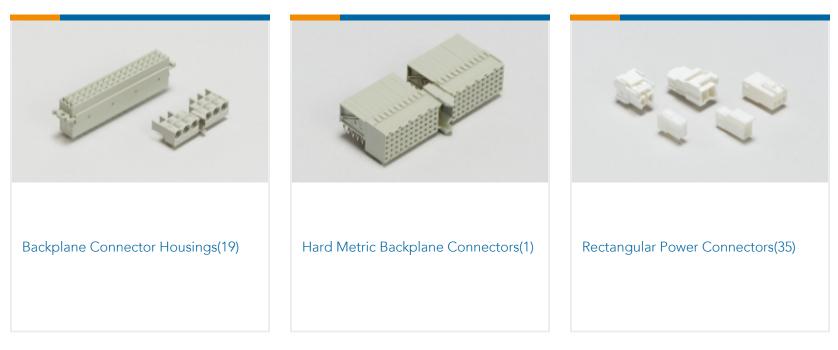
# 5223524-1

Backplane Connector Housings, Board-to-Board, 30 Position, 5 Row, 6 Column, Housing for Male Terminals, Sealable, Z-PACK Future Bus+





# Also in the Series | Z-PACK Future Bus+



# Customers Also Bought



| TE Part #415340-1<br>PCB JACK, RTANG, SMB | TE Part #1489951-1<br>XFP CAGE ASSEMBLY | TE Part #5787446-1<br>HDR ASY,VERT,NO KEY,RET TAIL | TE Part #2199230-4<br>M.2 0.5PITCH 4.2H KEY E 15U'' AU |
|---|---|--|--|
|   |   |  |  |



# Documents

#### CAD Files

# 3D PDF

3D

Customer View Model

ENG\_CVM\_CVM\_5223524-1\_O.2d\_dxf.zip

English

# 5223524-1

Backplane Connector Housings, Board-to-Board, 30 Position, 5 Row, 6 Column, Housing for Male Terminals, Sealable, Z-PACK Future Bus+



**Customer View Model** 

ENG\_CVM\_CVM\_5223524-1\_O.3d\_igs.zip

English

Customer View Model

ENG\_CVM\_CVM\_5223524-1\_O.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

**Product Specifications** 

Application Specification

English

Agency Approvals

UL Report

English